504859972 04/09/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4906711

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BRENDON LEWIS JOHNSON	02/01/2018
ANDREW EVAN GRUBER	01/23/2018
JAY CHUNSUP YUN	01/23/2018
RAHUL GULATI	04/02/2018
DONGHYUN KIM	01/23/2018
ALEX KWANG HO JONG	01/25/2018

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address: 5775 MOREHOUSE DRIVE	
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15850907	

CORRESPONDENCE DATA

Fax Number: (651)735-1102

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 651 735 1100

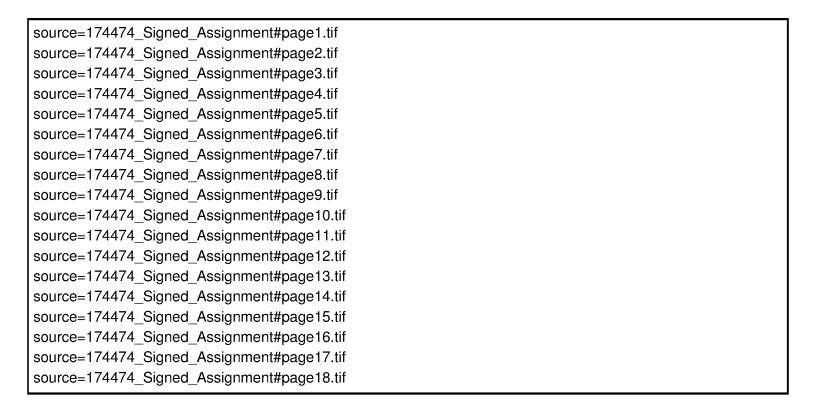
Email: pairdocketing@ssiplaw.com SHUMAKER & SIEFFERT, P. A. **Correspondent Name:** Address Line 1: 1625 RADIO DRIVE, SUITE 100 Address Line 4: WOODBURY, MINNESOTA 55125

ATTORNEY DOCKET NUMBER: 1414-421US01/174474	
NAME OF SUBMITTER:	KAYLA A. TAHTI
SIGNATURE:	/Kayla A. Tahti/
DATE SIGNED:	04/09/2018

Total Attachments: 18

PATENT REEL: 045484 FRAME: 0009

504859972



WHEREAS, WE,

- 1. Brendon Lewis JOHNSON, a citizen of Canada, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to TILE-BASED CHECK VALUES FOR DATA CONTENT INTEGRITY IN A GPU SUBSYSTEM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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Done at	San Diego, CA, on	Feb. 1, 2018	Brendon Lewis JOHNSON
-	LOCATION	DATE	Brendon Lewis JOHNSON
Done at	, on		
	LOCATION	DATE	Andrew Evan GRUBER
Done at _	, on		
	LOCATION	DATE	Jay Chunsup YUN
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-	LOCATION	DATE	Rahul GULATI
Done at	, on		
	LOCATION	DATE	Donghyun KIM
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Done at	LOCATION , on		Alex Kwang Ho JONG

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	LOCATION	DATE	Brendon Lewis JOHNSON
Done at 🛊	Dexboro, Mff., o LOCATION	n 1/23/2018 DATE	Andrew Evan GRUBER
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^	LOCATION	DATE	Donghyun KIM
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_ 0210 410_	LOCATION	DATE	Alex Kwang Ho JONG

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Done at		, on		
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Done at	San Diejo	, on	04/32/2018 DATE	Rail (what
-	LOCATION		DATE	Rahul GULATI
Done at		_, on _	DATE	
	LOCATION		DATE	Donghyun KIM
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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Done at		, on		
	LOCATION		DATE	Brendon Lewis JOHNSON
Done at		, on		
_	LOCATION	 ^ · · . 	DATE	Andrew Evan GRUBER
Done at		, on		
	LOCATION		DATE	Jay Chunsup YUN
Done at	LOCATION	, on		
-	LOCATION	'	DATE	Rahul GULATI
Done at		, on		
	LOCATION	_,	DATE	Donghyun KIM
Done at	San Dieno	on 4	Jan 25, 2018 DATE	aulu
_ 31.0	LOCATION	, ~	DATE	Alex Kwang Ho JONG

PATENT REEL: 045484 FRAME: 0028

RECORDED: 04/09/2018